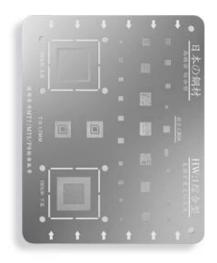
REBALLING STENCIL

— HUAWEI CPU series —



Product Usage



MATERIAL	Imported steel
BRAND	BESTOOL
PRODUCT NAME	Reballing Stencil
WEIGHT	7g
TYPE	Precise alignment Strong toughness Non-stick ti

▼ CHARACTERISTICS

This product is used for BGA tinning repair of the HUAWEI series. Imported steel, anti-rolling anti-deformation, automatic alignment, accurate hole position, non-stick tin, good toughness, good off-grid.

PRODUCT INFORMATION



IMPORTED STEEL

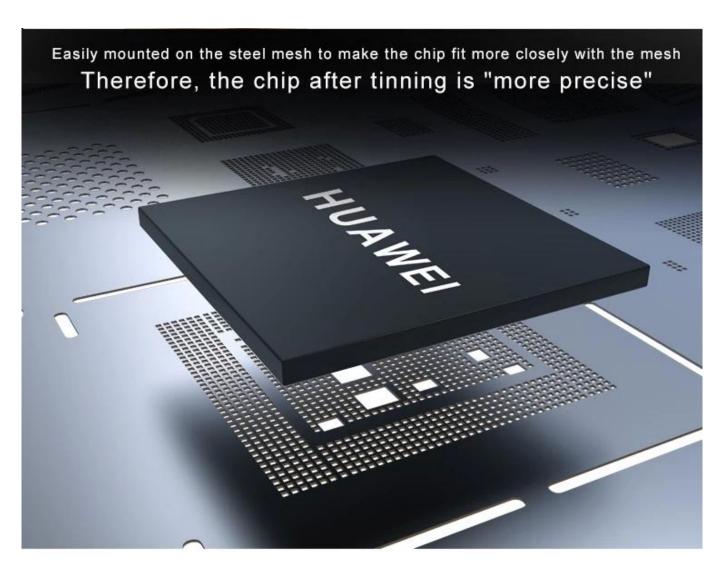
HIGH TOUGHNESS

GOOD PRODUCTS ARE NOT ONLY

EXCELLENT FORGING PROCESSES,

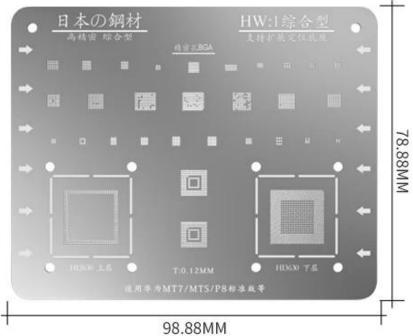
BUT THE REAL CORE LIES IN THE

SELECTION OF DELICATE MATERIALS.









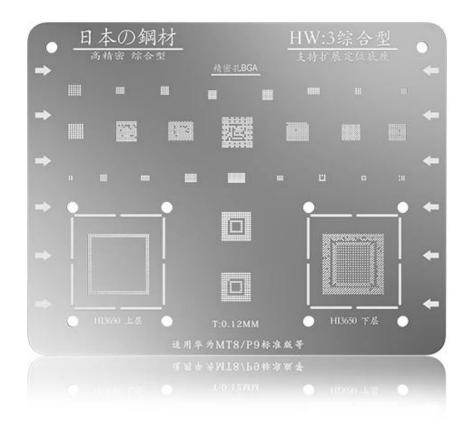
Thin to 0.12mm

Precise die-casting Iform heating





HUAWEI MT8/P9



HUAWEI MT7/MTS/P8

